



UPDATED 1.15.21

**NDIA**  
AT THE HEART  
OF THE MISSION

# ELECTRONICS DIVISION MEETING

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January 27 – 28, 2021 | [NDIA.org/ElectronicsDivJan](https://NDIA.org/ElectronicsDivJan)

# AGENDA

WEDNESDAY, JANUARY 27

1:30 – 1:45 pm

## WELCOME AND INTRODUCTIONS

**Irene Lau**

Avionics & Federal Research Strategic Marketing, Intel Corporation  
Chair, Electronics Division, National Defense Industrial Association (NDIA)

1:45 – 2:30 pm

## THE GREAT-POWER COMPETITION WITH CHINA

**Dr. Bill LaPlante**

President and Chief Executive Officer, Draper

**Dr. Andrew Palowitch**

Chief Executive Officer, Octagon II, Inc.

2:30 – 3:30 pm

## CHIPS AND AFA

**Dr. Michael Fritze**

Vice President, Potomac Institute for Policy Studies  
*Moderator*

**Jim Will**

Director, Business Development, Micross Components  
*Moderator*

**Bob McClellan**

Principal Solutions Architect, Micron Technology, Inc.

**Claire Sanderson**

Senator Cornyn's Office

**James P. Libous**

Fellow, Lockheed Martin Corporation

**Jimmy Goodrich**

Vice President, Global Policy, Semiconductor Industry Association

**Jon Cardinal**

Senator Schumer's Office

3:30 – 3:45 pm

## BREAK

3:45 – 5:15 pm

## MICROELECTRONICS COMMONS

**Mark Rosker**

Director, Microsystems Technology Office, DARPA

5:15 – 5:20 pm

## CLOSING REMARKS

**Ross Niebergall**

Vice President and Chief Technology Officer, L3Harris Technologies

**THURSDAY, JANUARY 28****1:20 – 1:30 pm****OPENING REMARKS****Irene Lau**

Avionics & Federal Research Strategic Marketing, Intel Corporation  
Chair, Electronics Division, NDIA

**Shawn Fetterolf**

Government Programs, Synopsys, Inc.  
Vice Chair, Electronics Division, NDIA

**1:30 – 1:45 pm****NDIA UPDATE****Dave Chesebrough**

Vice President, Divisions, NDIA

**1:45 – 2:45 pm****EDA SECURITY SIGN-OFF FOR ASIC TAPE-OUT****Serge Leef**

Program Manager, DARPA  
*Moderator*

**Deirdre Hanford**

Chief Security Officer, Synopsys, Inc.  
*Invited*

**Steve Carlson**

Technology and Market Strategist, Cadence Design Systems

**Rich Powlowsky**

Director, Government Programs, Siemens Industrial Software

**Shekhar Borkar**

Senior Director, Technology, Qualcomm

**Sergey Shumarayev**

Senior Principal Engineer, Intel Corporation  
*Invited*

**2:45 – 3:00 pm****BREAK**

3:00 – 4:00 pm

## **HARDWARE ASSURANCE IN INDUSTRY SECTORS THAT RELY ON TRUSTED AND ASSURED MICROELECTRONICS**

**Donald Davidson**

Director, Cyber-SCRM Programs

*Moderator*

**Gloria D’Anna**

RF Systems Engineer, Ford Motor Company

Co-Chair, SAE G-32, Cyber Physical Systems, Boeing

**Joe Weiss, CISM CRISC**

Managing Partner, Applied Control Solutions, LLC

Managing Director, ISA99

Fellow, ISA

Senior Member, IEEE

**Thomas Kent**

Manager, Cyber Trust and Analytics Division, Battelle Memorial Institute

**John Chandy**

Director, CHEST Center, University of Connecticut

**Lee Slezak**

Manager, Vehicle Systems, U.S. Department of Energy

4:00 – 4:30 pm

## **IARPA’S MICROELECTRONIC EFFORTS**

**Dr. Pedro Espina**

Director, Office of Collections, Intelligence Advanced Research Projects Activity (IARPA)

4:30 – 4:40 pm

## **CLOSING REMARKS**

**Irene Lau**

Avionics & Federal Research Strategic Marketing, Intel Corporation

Chair, Electronics Division, NDIA

**Shawn Fetterolf**

Government Programs, Synopsys, Inc.

Vice Chair, Electronics Division, NDIA

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